

DECLARATION (37 CFR 1.63) AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name; and

I believe that I am the original, first, and sole inventor (if only one name is listed below), or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **METHOD AND APPARATUS FOR WELDING**, specification for which

APPARATUS FOR WEI	Ding, specification for wh	icii		
is attached h	ereto.			
🛛 was filed	November 28, 2001	, Serial No		
I hereby state that I have re any amendment referred t		ontents of the above-identified	specification, including the cla	nims, as amended by
I acknowledge the duty to Federal Regulations, §1.5		s material to patentability of th	nis application in accordance w	ith Title 37, Code of
inventor's certificate listed	ority benefits under Title 35 below and have also identifi ion on which priority is clair	ied any foreign application for	l/or §365 of any foreign applicate patent or inventor's certificate	ation(s) for patent or having a filing date
Application Serial No.	Country	Filing Date		Priority Claimed
I hereby claim priority be	nefits under Title 35, United	States Code §119 of any prov	isional application(s) for patent	t listed below:
Application Serial No.		Filing Date	Priority Claimed	
60/253,479	N	ovember 28, 2000	Yes	
as the subject matter of eachy the first paragraph of	th of the claims of this applica Fitle 35, United States Code, ations, §1.56(a) which becam	ation is not disclosed in the prio §112, I acknowledge the duty	United States application(s) lister United States application(s) in to disclose material information application and	the manner provided on as defined in Title
Application Serial No.		Filing Date	Status (Patented, Pending, Abandone	d)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following persons registered to practice before the Patent and Trademark Office as my attorneys with full power of substitution and revocation to prosecute this application and all divisions and continuations thereof and to transact all business in the Patent and Trademark Office connected therewith: David R. Saliwanchik, Reg. No. 31,794; Jeff Lloyd, Reg. No. 35,589; Doran R. Pace, Reg. No. 38,261; Christine Q. McLeod, Reg. No. 36,213; Jean Kyle, Reg. No. 36,987: Jay M. Sanders, Reg. No. 39,355; James S. Parker, Reg. No. 40,119; Frank C. Eisenschenk., Reg. No. 45,332, Seth M. Blum, Reg. No. 45,489; Glenn P. Ladwig, Reg. No. 46,853; Margaret Efron, Reg. No. 47,545; and Jon Michael Gibbs, Reg. No. 47,594.

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			Docket No. MOC-100XC1			
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-						
	-	Date				

Signature of Fourth Joint Inventor